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August 2015

FGA6530WDF 650 V, 30 A Field Stop Trench IGBT

Features

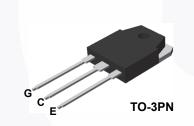
- Maximum Junction Temperature : $T_J = 175^{\circ}C$
- · Positive Temperaure Co-efficient for Easy Parallel Operating
- High Current Capability
- Low Saturation Voltage: $V_{CE(sat)}$ = 1.8 V(Typ.) @ I_C = 30 A
- + 100% of the Parts Tested for $I_{LM}(1)$
- High Input Impedance
- · Fast Switching
- Tighten Parameter Distribution
- · RoHS Compliant

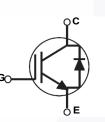
General Description

Using novel field stop IGBT technology, Fairchild's new series of field stop 3rd generation IGBTs offer the optimum performance for welder and industial applications where low conduction and switching losses are essential.

Applications

- Welder and Industrial Application
- Power Factor Correction





Absolute Maximum Ratings T_C = 25°C unless otherwise noted

Symbol	Description		FGA6530WDF	Unit	
V _{CES}	Collector to Emitter Voltage	Collector to Emitter Voltage		V	
V	Gate to Emitter Voltage		± 20	V	
V _{GES}	Transient Gate to Emitter Voltage		± 30	V	
I _C	Collector Current	@ T _C = 25 ^o C	60	А	
'C	Collector Current	@ T _C = 100°C	30	А	
I _{LM (1)}	Pulsed Collector Current	@ T _C = 25 ^o C	90	А	
I _{CM (2)}	Pulsed Collector Current		90	А	
I _F	Diode Forward Current	@ T _C = 25°C	30	А	
'F	Diode Forward Current	@ T _C = 100°C	15	А	
I _{FM}	Pulsed Diode Maximum Forward Curren	60	А		
P _D	Maximum Power Dissipation	@ T _C = 25°C	176	W	
· D	Maximum Power Dissipation	timum Power Dissipation $@ T_C = 100^{\circ}C$		W	
TJ	Operating Junction Temperature	erating Junction Temperature		°C	
T _{stg}	Storage Temperature Range		-55 to +175	°C	
TL	Maximum Lead Temp. for soldering Purposes, 1/8" from case for 5 seconds		300	°C	

Notes:

1. V_{CC} = 400 V, V_{GE} = 15 V, I_{C} = 90 A, R_{G} = 55.9 $\Omega,$ Inductive Load

2. Repetitive rating: Pulse width limited by max. junction temperature

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Thermal Characteristics

Symbol	Parameter	FGA6530WDF	Unit		
$R_{\theta JC}$ (IGBT)	Thermal Resistance, Junction to Case, Max.	0.85	°C/W		
R _{θJC} (Diode) Thermal Resistance, Junction to Case, Max.		3.5	°C/W		
R _{0JA} Thermal Resistance, Junction to Ambient, Max.		40	°C/W		

Package Marking and Ordering Information

Part Number	Top Mark	Package	Packing Method	Reel Size	Tape Width	Quantity	
FGA6530WDF	FGA6530WDF	TO-3PN	Tube	-	-	30	

Electrical Characteristics of the IGBT T_C = 25°C unless otherwise noted

Symbol Parameter		Test Conditions	Min.	Тур.	Max.	Unit
Off Charac	toristics					
BV _{CES}	Collector to Emitter Breakdown Voltage	V _{GE} = 0 V, I _C = 1 mA	650	_	_	V
ΔBV_{CES} / ΔT_{J}	Temperature Coefficient of Breakdown Voltage	$I_{\rm C} = 1$ mA, Reference to 25°C	-	0.52	-	V/ºC
I _{CES}	Collector Cut-Off Current	V _{CE} = V _{CES} , V _{GE} = 0 V	-	-	250	μA
I _{GES}	G-E Leakage Current	$V_{GE} = V_{GES}, V_{CE} = 0 V$	-	-	±400	nA
On Charac	teristics				1	
V _{GE(th)}	G-E Threshold Voltage	$I_{\rm C}$ = 30 mA, $V_{\rm CE}$ = $V_{\rm GE}$	4.1	5.6	7.6	V
()		I _C = 30 A, V _{GE} = 15 V	-	1.8	2.3	V
V _{CE(sat)} Collector to Emitter Saturation Voltage		$I_{\rm C}$ = 30 A, $V_{\rm GE}$ = 15 V, $T_{\rm C}$ = 175°C	-	2.4	-	V
Dynamic C	haracteristics					
C _{ies}	Input Capacitance	$V_{CE} = 30 V, V_{GE} = 0 V,$	-	1072	-	pF
C _{oes}	Output Capacitance		-	36	-	pF
C _{res}	Reverse Transfer Capacitance	f = 1MHz	-	13	-	pF
Switching	Characteristics	•				
t _{d(on)}	Turn-On Delay Time		- 1	12	-	ns
t _r	Rise Time		-	19.2	-	ns
t _{d(off)}	Turn-Off Delay Time	V _{CC} = 400 V, I _C = 30 A,	-	42.4	-	ns
t _f	Fall Time	R _G = 6 Ω, V _{GE} = 15 V,	-	7.2	-	ns
E _{on}	Turn-On Switching Loss	Inductive Load, T _C = 25°C	-	960	-	uJ
E _{off}	Turn-Off Switching Loss		-	162	-	uJ
E _{ts}	Total Switching Loss		-	1122	-	uJ
t _{d(on)}	Turn-On Delay Time		-	12.8	-	ns
t _r	Rise Time	1	-	27.2	-	ns
t _{d(off)}	Turn-Off Delay Time	V _{CC} = 400 V, I _C = 30 A,	-	46.4	-	ns
t _f	Fall Time	R _G = 6 Ω, V _{GE} = 15 V,	-	12.8	-	ns
Eon	Turn-On Switching Loss	Inductive Load, T _C = 175 ^o C	-	1430	-	uJ
E _{off}	Turn-Off Switching Loss		-	310	-	uJ
Lott	5					

Electrical Characteristics of the IGBT (Continued)

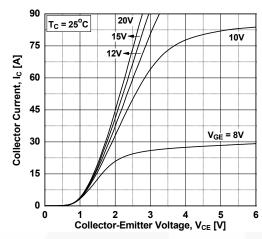
Symbol	Parameter	Test Conditions	Min.	Тур.	Max	Unit
Qg	Total Gate Charge	V _{CE} = 400 V, I _C = 30 A, V _{GE} = 15 V	-	37.4	-	nC
Q _{ge}	Gate to Emitter Charge		-	7.2	-	nC
Q _{gc}	Gate to Collector Charge		-	15	-	nC

Electrical Characteristics of the Diode T_C = 25°C unless otherwise noted

Symbol	Parameter		Test Conditions			Min.	Тур.	Мах	Unit
V _{FM}	Diode Forward Voltage	I _F =	15 A		T _C = 25°C	-	1.7	2.6	V
				ſ	T _C = 175°C	-	1.62	-	
E _{rec}	Reverse Recovery Energy				T _C = 175 ^o C		76	-	uJ
t _{rr}	Diode Reverse Recovery Time	۱ _F =	15 A, dI _F /dt = 200 A/μs		T _C = 25 ^o C		81	-	ns
					T _C = 175°C	-	257		
Q _{rr}	Diode Reverse Recovery Charge			Ī	T _C = 25 ^o C	-	254	-	nC
~n	Didde Noterice Network Onlinge			Ī	T _C = 175 ^o C	-	1189	-	

Typical Performance Characteristics

Figure 1. Typical Output Characteristics





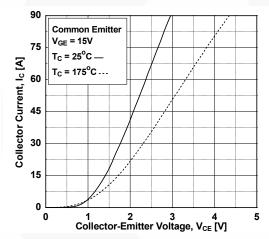


Figure 5. Saturation Voltage vs. V_{GE}

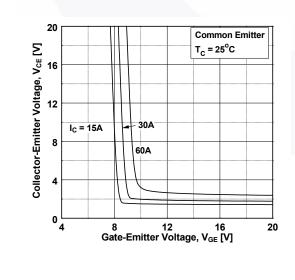
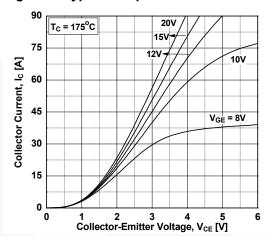
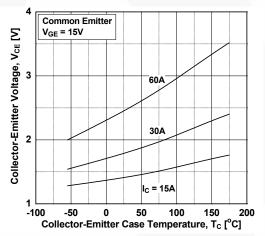


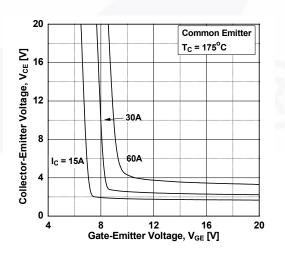
Figure 2. Typical Output Characteristics











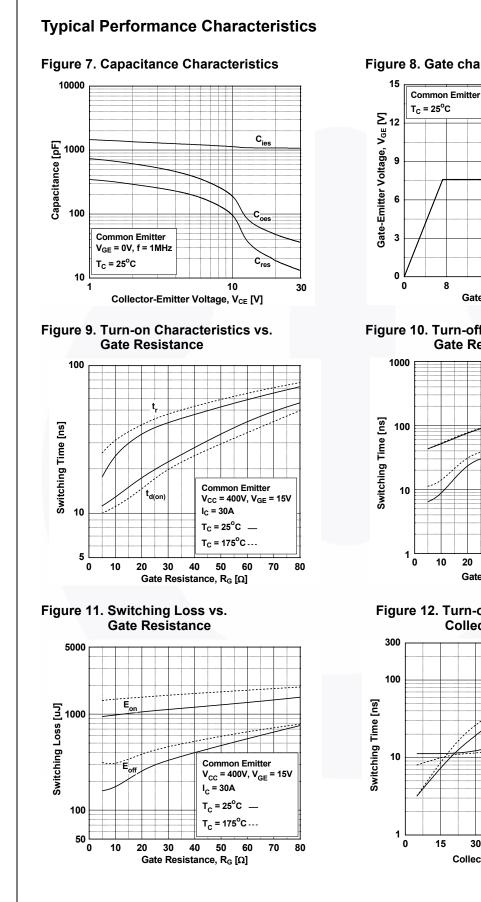
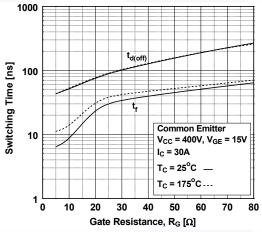


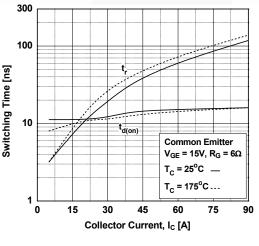
Figure 8. Gate charge Characteristics

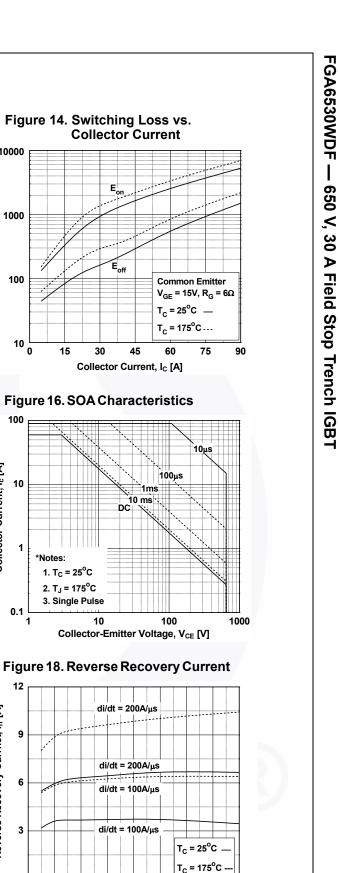
Figure 10. Turn-off Characteristics vs.

Gate Resistance









Eon

E_{off}

45

'nc

.........

Forward Current, I_F [A]

60

70

50

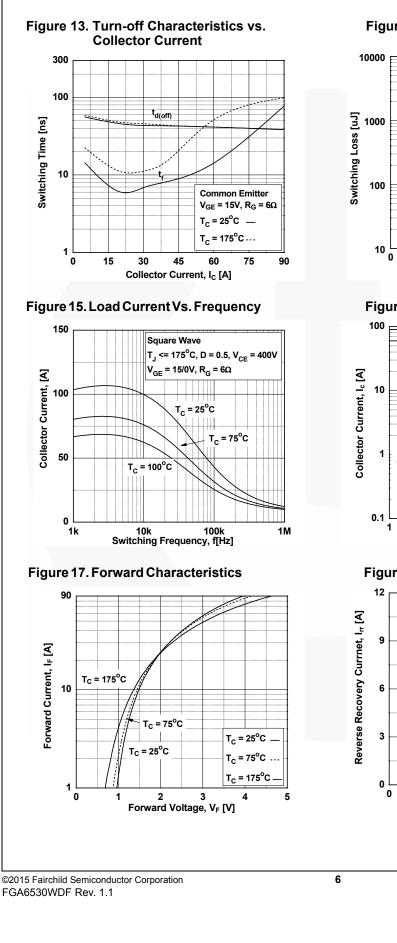
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*Notes:

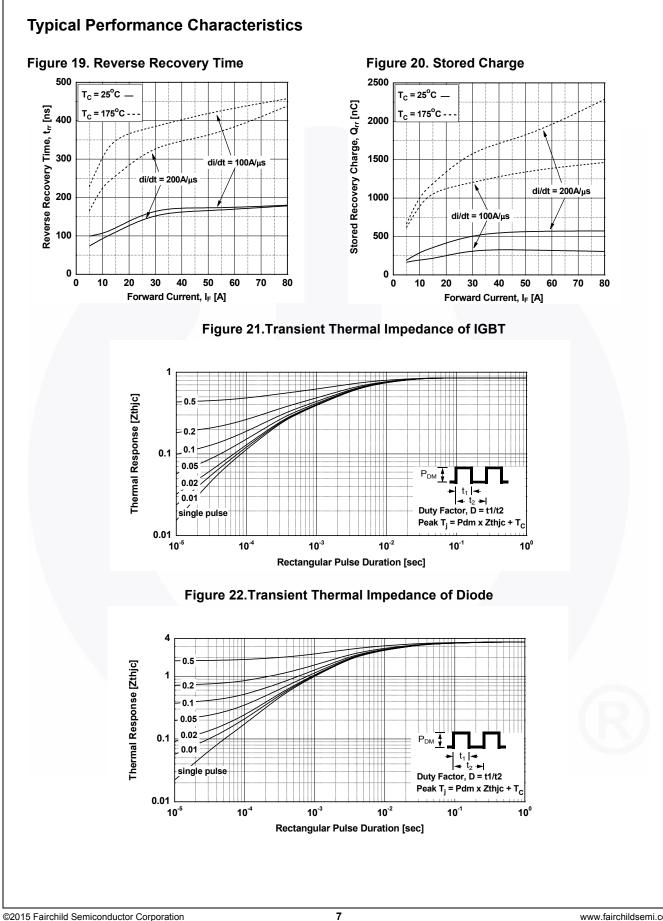
1. $T_{C} = 25^{\circ}C$ 2. T_J = 175^oC 3. Single Pulse

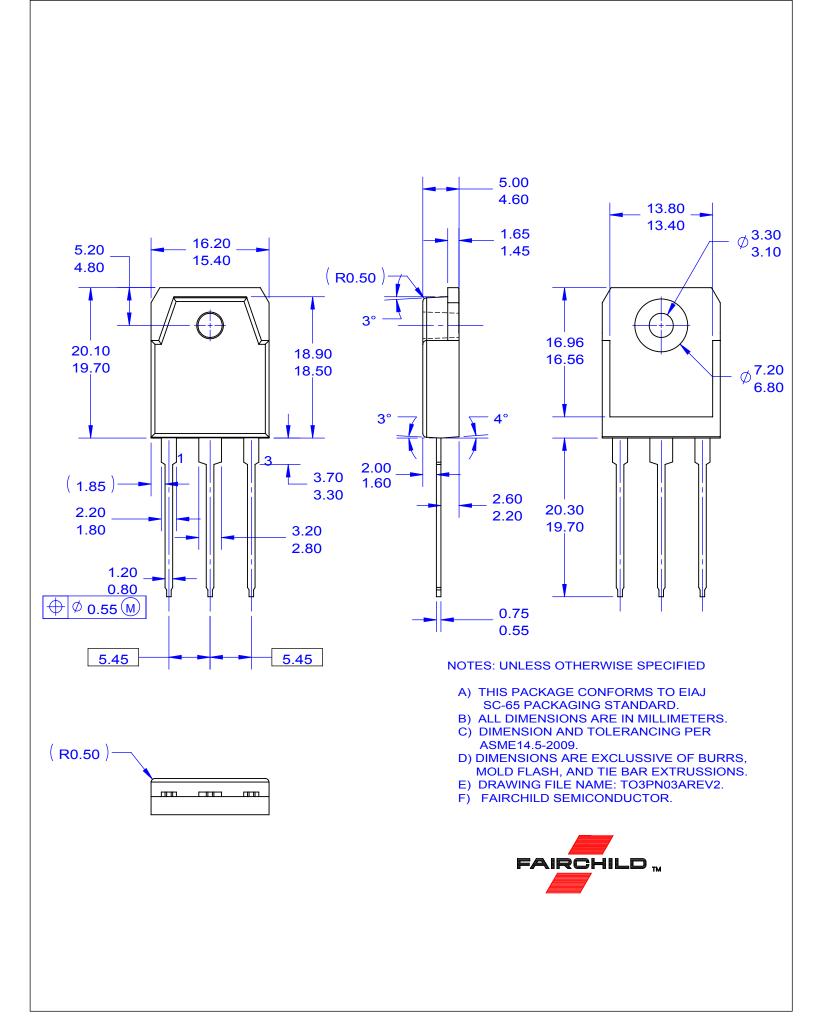
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Typical Performance Characteristics

10 20 30 40 80





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